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Advanced Materials for Plasmonics, Metamaterials and Metasurfaces

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Message from the Guest Editors

Metamaterials typically refer to artificial three-dimensional (3D), volumetric media composed of bulk metallic and/or dielectric constituent elements which exhibit electromagnetic responses that are not found in nature and are radically different from those of their constituent two-dimensional materials As embodiments metamaterials, metasurfaces are planar devices composed of spatially varying subwavelength elements that could be designed to control the phase, amplitude, wavelength, and polarization of waves solely via engineering the geometry. Compared to traditional devices, the light weight, low loss, integrable and conformable design metasurfaces very attractive. Plasmonic metamaterials promise a far-reaching scientific and industrial impact.

This Special Issue seeks to provide a current snapshot of recent advances, as well as highlight ongoing challenges in plasmonics, metamaterials, and metasurfaces, through collecting expert views and article contributions across a broad spectrum, including on the simulation, fabrication, experiment, and application of plasmonics, metamaterials, and metasurfaces.













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Message from the Editor-in-Chief

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